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Vishay Semiconductors

## Ultralow V<sub>F</sub> Hyperfast Rectifier for Discontinuous Mode PFC, 8 A FRED Pt<sup>®</sup>



2L TO-220 FullPAK



VS-8ETL06FP-N3

| PRIMARY CHARACTERISTICS          |                   |  |  |  |
|----------------------------------|-------------------|--|--|--|
| I <sub>F(AV)</sub>               | 8 A               |  |  |  |
| V <sub>R</sub>                   | 600 V             |  |  |  |
| V <sub>F</sub> at I <sub>F</sub> | 0.81 V            |  |  |  |
| t <sub>rr</sub> typ.             | 60 ns             |  |  |  |
| T <sub>J</sub> max.              | 175 °C            |  |  |  |
| Package                          | 2L TO-220 FullPAK |  |  |  |
| Circuit configuration            | Single            |  |  |  |

#### **FEATURES**

- · Hyperfast recovery time
- Benchmark ultralow forward voltage drop
- 175 °C operating junction temperature
- · Low leakage current
- Fully isolated package (V<sub>INS</sub> = 2500 V<sub>RMS</sub>)
- UL pending
- Designed and qualified according to JEDEC®-JESD 47
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912">www.vishay.com/doc?99912</a>

#### **DESCRIPTION**

State of the art, ultralow  $V_F$ , soft-switching hyperfast rectifiers optimized for Discontinuous (Critical) Mode (DCM) Power Factor Correction (PFC).

The minimized conduction loss, optimized stored charge and low recovery current minimize the switching losses and reduce over dissipation in the switching element and snubbers.

The device is also intended for use as a freewheeling diode in power supplies and other power switching applications.

#### **APPLICATIONS**

AC/DC SMPS 70 W to 400 W

e.g. laptop and printer AC adaptors, desktop PC, TV and monitor, games units and DVD AC/DC power supplies.

| ABSOLUTE MAXIMUM RATINGS                    |                                   |                         |             |       |
|---|-----------------------------------|-------------------------|-------------|-------|
| PARAMETER                                   | SYMBOL                            | TEST CONDITIONS         | VALUES      | UNITS |
| Repetitive peak reverse voltage             | $V_{RRM}$                         |                         | 600         | V     |
| Average rectified forward current           | I <sub>F(AV)</sub>                | T <sub>C</sub> = 142 °C | 8           | Α     |
| Non-repetitive peak surge current           | I <sub>FSM</sub>                  | T <sub>J</sub> = 25 °C  | 175         |       |
| Repetitive peak forward current             | I <sub>FM</sub>                   |                         | 16          |       |
| Operating junction and storage temperatures | T <sub>J</sub> , T <sub>Stg</sub> |                         | -65 to +175 | °C    |

| <b>ELECTRICAL SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C unless otherwise specified) |                                     |  |      |      |      |       |
|--|-------------------------------------|--|------|------|------|-------|
| PARAMETER  | SYMBOL                              | TEST CONDITIONS  | MIN. | TYP. | MAX. | UNITS |
| Breakdown voltage,<br>blocking voltage   | V <sub>BR</sub> ,<br>V <sub>R</sub> | I <sub>R</sub> = 100 μA  | 600  | -    | -    |       |
| Forward voltage V <sub>F</sub>   | I <sub>F</sub> = 8 A                | -  | 0.96 | 1.05 | V    |       |
|  | VF                                  | I <sub>F</sub> = 8 A, T <sub>J</sub> = 150 °C                  | -    | 0.81 | 0.86 |       |
| Reverse leakage current I <sub>R</sub>   |                                     | $V_R = V_R$ rated  | -    | 0.05 | 5    | μA    |
| neverse leakage current  | I <sub>R</sub>                      | T <sub>J</sub> = 150 °C, V <sub>R</sub> = V <sub>R</sub> rated | -    | 20   | 100  | μΑ    |
| Junction capacitance   | C <sub>T</sub>                      | V <sub>R</sub> = 600 V   | -    | 17   | -    | pF    |
| Series inductance  | L <sub>S</sub>                      | Measured lead to lead 5 mm from package body - 8.0 -           |      | nΗ   |      |       |



| <b>DYNAMIC RECOVERY CHARACTERISTICS</b> (T <sub>C</sub> = 25 °C unless otherwise specified) |                         |  |  |      |      |      |       |
|---|-------------------------|--|--|------|------|------|-------|
| PARAMETER   | SYMBOL                  | TEST CONDITIONS  |  | MIN. | TYP. | MAX. | UNITS |
|   |                         | $I_F = 1 \text{ A}, dI_F/dt = 100 \text{ A/}\mu\text{s}, V_R = 30 \text{ V}$ |  | -    | 60   | 100  |       |
| Reverse recovery time t <sub>rr</sub>   | +                       | $I_F = 8 \text{ A}, dI_F/dt = 100 \text{ A/}\mu\text{s}, V_R = 30 \text{ V}$ |  | -    | 150  | 250  | ns    |
|   | T <sub>J</sub> = 25 °C  |  | -  | 170  | -    |      |       |
|   | T <sub>J</sub> = 125 °C |  | -  | 250  | -    |      |       |
| Peak recovery current I <sub>RRM</sub>  | 1                       | T <sub>J</sub> = 25 °C   | I <sub>F</sub> = 8 A<br>dI <sub>F</sub> /dt = 200 A/µs<br>V <sub>B</sub> = 390 V | -    | 15   | -    | Α     |
|   | IRRM                    | T <sub>J</sub> = 125 °C  |  | -    | 20   | -    | ^     |
| Reverse recovery charge Q <sub>rr</sub>   | 0                       | T <sub>J</sub> = 25 °C   | ••   | -    | 1.3  | -    | μC    |
|   | Q <sub>rr</sub>         | T <sub>J</sub> = 125 °C  |  | -    | 2.6  | -    | μΟ    |

| THERMAL - MECHANICAL SPECIFICATIONS             |                                   |   |              |      |            |                        |
|---|-----------------------------------|---|--------------|------|------------|------------------------|
| PARAMETER                                       | SYMBOL                            | TEST CONDITIONS                             | MIN.         | TYP. | MAX.       | UNITS                  |
| Maximum junction and storage temperature range  | T <sub>J</sub> , T <sub>Stg</sub> |   | -65          | -    | 175        | °C                     |
| Thermal resistance, junction-to-case            | R <sub>thJC</sub>                 |   | ı            | 3.4  | 4.3        | °C/W                   |
| Thermal resistance, junction-to-ambient per leg | R <sub>thJA</sub>                 | Typical socket mount                        | -            | -    | 70         |                        |
| Thermal resistance, case-to-heatsink            | R <sub>thCS</sub>                 | Mounting surface, flat, smooth, and greased | -            | 0.5  | -          |                        |
| Weight  |                                   |   | 1            | 2.0  | -          | g                      |
| weignt  |                                   |   | -            | 0.07 | -          | OZ.                    |
| Mounting torque                                 |                                   |   | 6.0<br>(5.0) | -    | 12<br>(10) | kgf · cm<br>(lbf · in) |
| Marking device                                  |                                   | Case style 2L TO-220 FullPAK                | 8ETL06FP     |      |            |                        |

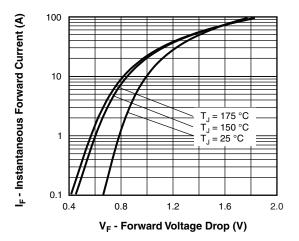


Fig. 1 - Typical Forward Voltage Drop Characteristics

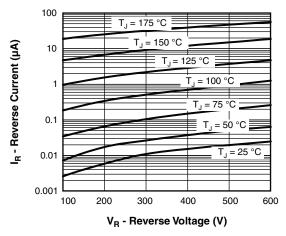


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage



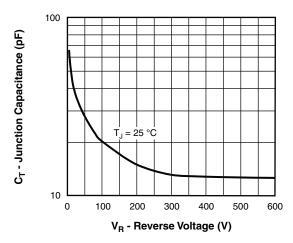


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

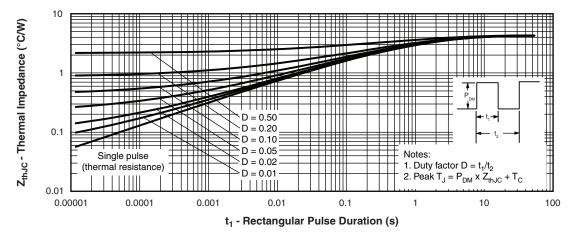


Fig. 4 - Maximum Thermal Impedance Z<sub>thJC</sub> Characteristics

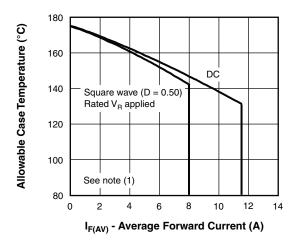


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

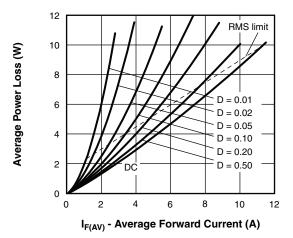


Fig. 6 - Forward Power Loss Characteristics

#### Note

 $\begin{array}{ll} \text{(1)} & \text{Formula used: } T_C = T_J - (Pd + Pd_{REV}) \times R_{thJC}; \\ Pd = \text{forward power loss} = I_{F(AV)} \times V_{FM} \text{ at } (I_{F(AV)}/D) \text{ (see fig. 5)}; \\ Pd_{REV} = \text{inverse power loss} = V_{R1} \times I_R \text{ (1 - D)}; I_R \text{ at } V_{R1} = \text{rated } V_R \\ \end{array}$ 



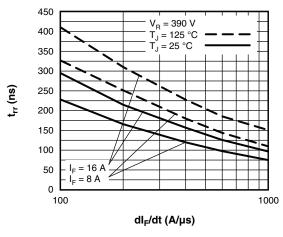


Fig. 7 - Typical Reverse Recovery Time vs. dl<sub>F</sub>/dt

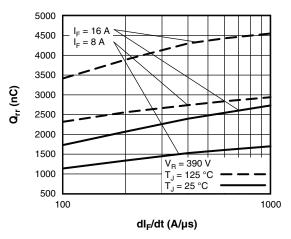
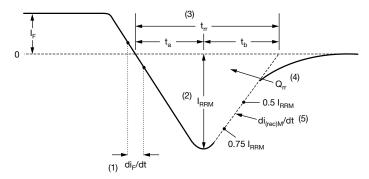


Fig. 8 - Typical Stored Charge vs. dl<sub>F</sub>/dt



- (1) di<sub>F</sub>/dt rate of change of current through zero crossing
- (2) I<sub>RRM</sub> peak reverse recovery current
- (3) t<sub>rr</sub> reverse recovery time measured from zero crossing point of negative going I<sub>F</sub> to point where a line passing through 0.75 I<sub>RRM</sub> and 0.50 I<sub>RRM</sub> extrapolated to zero current.
- (4)  $\mathbf{Q}_{rr}$  area under curve defined by  $\mathbf{t}_{rr}$  and  $\mathbf{I}_{RRM}$

$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$

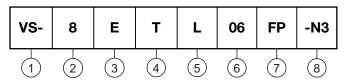
(5)  $di_{(rec)M}/dt$  - peak rate of change of current during  $t_b$  portion of  $t_{rr}$ 

Fig. 9 - Reverse Recovery Waveform and Definitions



### **ORDERING INFORMATION TABLE**

Device code



1 - Vishay Semiconductors product

2 - Current rating (8 = 8 A)

**3** - E = single

- T = TO-220, D<sup>2</sup>PAK (TO-263AB)

L = ultralow V<sub>F</sub> hyperfast recovery

6 - Voltage rating (06 = 600 V)

7 - FP = 2L TO-220 FullPAK

8 - Environmental digit:

-N3 = halogen-free, RoHS-compliant, and totally lead (Pb)-free

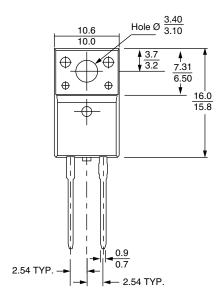
| ORDERING INFORMATION (Example) |                  |                        |                         |  |  |
|--------------------------------|------------------|------------------------|-------------------------|--|--|
| PREFERRED P/N                  | QUANTITY PER T/R | MINIMUM ORDER QUANTITY | PACKAGING DESCRIPTION   |  |  |
| VS-8ETL06FP-N3                 | 50               | 1000                   | Antistatic plastic tube |  |  |

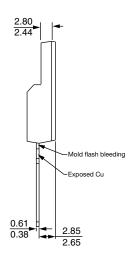
| LINKS TO RELATED DOCUMENTS                 |                          |  |  |  |
|--|--------------------------|--|--|--|
| Dimensions <u>www.vishay.com/doc?96157</u> |                          |  |  |  |
| Part marking information                   | www.vishay.com/doc?95392 |  |  |  |
| SPICE model                                | www.vishay.com/doc?96054 |  |  |  |

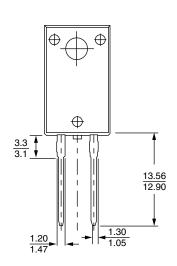


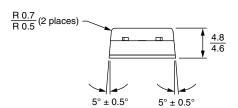
### 2L TO-220 FullPAK

#### **DIMENSIONS** in millimeters









Bottom view



### **Legal Disclaimer Notice**

Vishay

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